



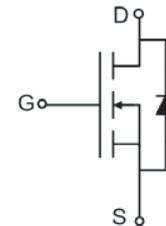
N-Channel Enhancement Mode Power MOSFET

General Features

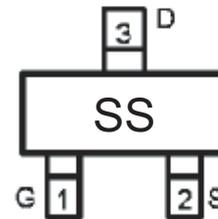
- $V_{DS} = 50V, I_D = 0.22A$
 $R_{DS(ON)} < 6\Omega @ V_{GS}=4.5V$
 $R_{DS(ON)} < 3.5\Omega @ V_{GS}=10V$
- Lead free product is acquired
- Surface mount package

Application

- Direct logic-level interface: TTL/CMOS
- Drivers: relays, solenoids, lamps, hammers, display, memories, transistors, etc.
- Battery operated systems
- Solid-state relays
- Halogen-free
- P/N suffix V means AEC-Q101 qualified, e.g:RM138V



Schematic diagram



Marking and pin assignment



SOT-23 top view

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|--------|----------------|-----------|------------|------------|
| SS | RM138 | SOT-23 | Ø180mm | 8 mm | 3000 units |

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|----------------|------------|------------------|
| Drain-Source Voltage | V_{DS} | 50 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current-Continuous | I_D | 0.22 | A |
| Drain Current-Pulsed ^(Note 1) | I_{DM} | 0.88 | A |
| Maximum Power Dissipation | P_D | 0.35 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 150 | $^\circ\text{C}$ |

Thermal Characteristic

| | | | |
|---|-----------------|-----|--------------------|
| Thermal Resistance, Junction-to-Ambient ^(Note 2) | $R_{\theta JA}$ | 350 | $^\circ\text{C/W}$ |
|---|-----------------|-----|--------------------|

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

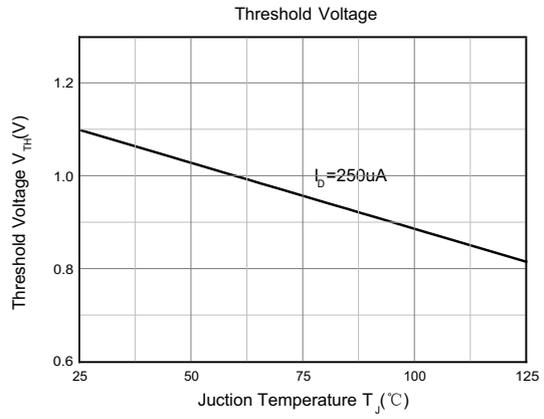
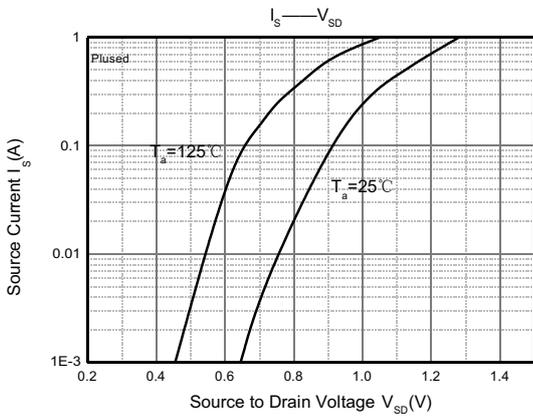
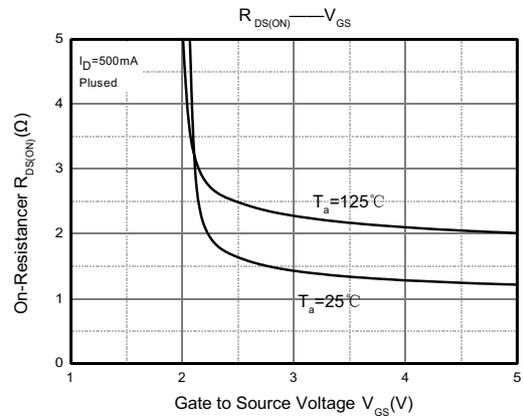
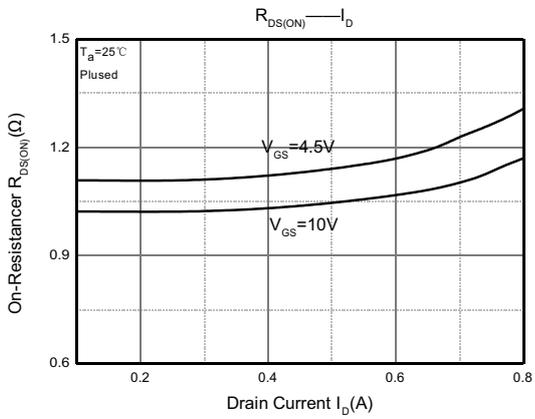
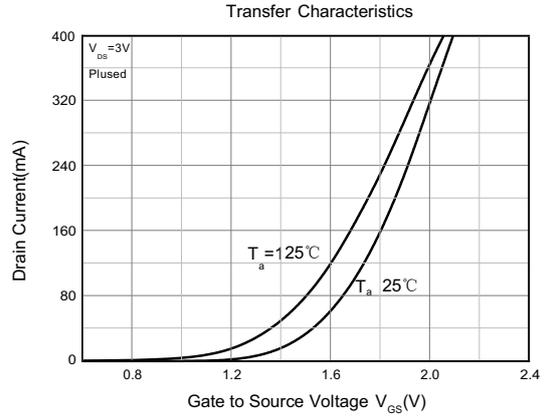
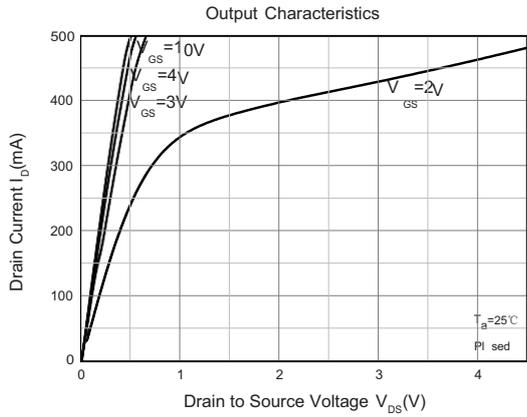
| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---------------------------------|------------|---------------------------|-----|-----|-----|---------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 50 | 65 | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=50V, V_{GS}=0V$ | - | - | 0.5 | μA |

| | | | | | | |
|--|--------------|--|------|-----|-----------|----------|
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 0.6 | 1.1 | 1.4 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}=4.5V, I_D=0.22A$ | - | 1.1 | 6 | Ω |
| | | $V_{GS}=10V, I_D=0.22A$ | - | 1.0 | 3.5 | Ω |
| Forward Transconductance | g_{FS} | $V_{DS}=10V, I_D=0.2A$ | 0.12 | - | - | S |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=25V, V_{GS}=0V,$ $F=1.0MHz$ | - | 27 | - | PF |
| Output Capacitance | C_{oss} | | - | 12 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 6 | - | PF |
| Switching Characteristics ^(Note 4) | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=30V, I_D=0.22A$ $V_{GS}=10V, R_{GEN}=6\Omega$ | - | 2.5 | - | nS |
| Turn-on Rise Time | t_r | | - | 6 | - | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 20 | - | nS |
| Turn-Off Fall Time | t_f | | - | 7 | - | nS |
| Total Gate Charge | Q_g | $V_{DS}=25V, I_D=0.3A,$ $V_{GS}=10V$ | - | 1.7 | 2.4 | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V_{SD} | $V_{GS}=0V, I_S=0.22A$ | - | - | 1.3 | V |
| Diode Forward Current ^(Note 2) | I_S | - | - | - | 0.22 | A |

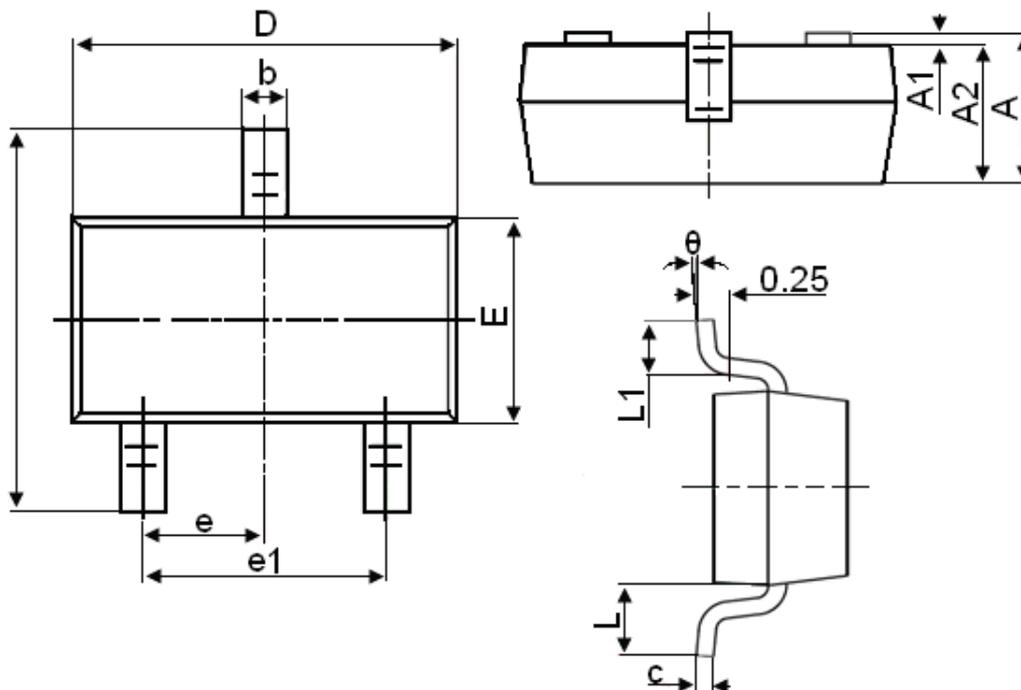
Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production

RATING AND CHARACTERISTICS CURVES (RM138)



SOT-23 Package Information



| Symbol | Dimensions in Millimeters | |
|----------|---------------------------|-------|
| | MIN. | MAX. |
| A | 0.900 | 1.150 |
| A1 | 0.000 | 0.100 |
| A2 | 0.900 | 1.050 |
| b | 0.300 | 0.500 |
| c | 0.080 | 0.150 |
| D | 2.800 | 3.000 |
| E | 1.200 | 1.400 |
| E1 | 2.250 | 2.550 |
| e | 0.950TYP | |
| e1 | 1.800 | 2.000 |
| L | 0.550REF | |
| L1 | 0.300 | 0.500 |
| θ | 0° | 8° |

Notes

1. All dimensions are in millimeters.
2. Tolerance ± 0.10 mm (4 mil) unless otherwise specified
3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
4. Dimension L is measured in gauge plane.
5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

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